

General tolerances	Unit	Requirements
Board moisture /EN 322/	[%]	5-13
Tolerance on the mean density /EN 323/	[%]	±10.0
Thickness tolerance /EN 324/ sanded boards	[mm]	±0.3
Length and width tolerance /EN 324/	[mm]	±5.0
Edge straightness tolerance /EN 324/	[mm/m]	±1.5
Squareness /EN 324/	[mm/m]	±2.0
Thermal conductivity /EN 12524/	[W/mK]	0.12
Water vapour diffusion resistance factor /EN 12524/	[μ]	u damp 15; u dry 50
Fire protection /EN 13986/		D-s2, d0 (thickness ≥ 9mm; density ≥ 600kg/m³) E (thickness ≥ 9mm; density ≥ 600kg/m³)
Formaldehyde content /EN 120/	[mg/100g]	E1*, E1 EPF-S**
General tolerances	Unit	Thickness ranges
		< 15 mm 15 - 20 mm > 20 mm
Thickness in relation to nominal dimension /EN 14323/	[mm]	±0.3 for abrasion category 1 and 2 ±0.5/-0.3 for abrasion category 3A, 3B and stumpy surfaces
Length and width - usual trade dimensions /EN 14323/	[mm]	±5
- cut to size boards	[mm]	±2.5
Warpage /EN 14323/	[mm/m]	±2
Edge splinters - usual trade dimensions /EN 14323/	[mm]	±10
- cut to size boards	[mm]	±3
Surface properties	Unit	Value
Surface defects /EN 14323/	[mm²/m²]	≤2
Length defects	[mm/m]	≤20
Resistance to scratching /EN 14323/	[N]	≥1.5
Resistance to stains /EN 14323/	[Level]	≥3
Susceptibility to cracking /EN 14323/	[Level]	≥3
Abrasion resistance /EN 14323/	[micro-lutions]	Class IP WP
Depending on the configuration of the layer construction, different levels can be achieved.		1 <50 <150
		2 ≥50 ≥150
		3A ≥150 ≥350
		3B ≥250 ≥650

Name	Value	Unit
Gross density /EN 197-1/	660	kg/m³
Bending strength (longitudinal) /DIN EN 310/	7 - 20	N/mm²
E-module (longitudinal) /DIN EN 310/	1200 - 3150	N/mm²
Grammage Eurodekor with 17.6 mm	11.6	kg/m²
Material dampness at delivery	5 - 13	%
Tensile strength rectangular	+2.0 [mm/m]	N/mm²
Thermal conductivity /EN 12524/	12	W/(mK)
Water vapour diffusion resistance factor /EN 12524/	moist 15; dry 50	-
Formaldehyde content: Varies depending on the product /EN 120/, /CARB/, /JIS A 5908/	E1*, EPF-S², CARB³, F**** (4)	
Deviation of density from average /EN 323/	±10.0	%
Thickness tolerance sanded boards /EN 323/	±0.3	[mm]
Length and width tolerance /EN 324/	±5.0	[mm]
Straightness of edges tolerance /EN 324/	±1.5	[mm]
Squareness /EN 324/	±2.0	[mm]
Fire safety EURODEKOR® /EN 13986/	D-s2, d0	
Fire safety EURODEKOR® Flammex E1 P2 B/B1/M1 /EN 13986/	B-s1, d0	

1) E1 formaldehyde class has a limit value of 8 mg and a moving half-year average of 6.5 mg HCHO/100g according to test method /EN 120/.

2) E1 EPF-S chipboard with reduced formaldehyde release has a limit value of 4.0 mg HCHO/100g according to /EN 120/.

3) CARB chipboard certified to /California Air Resources Board (CARB) regulation CCR-17-93120.2(a) – Phase 2/

4) F**** chipboard complies with formaldehyde class F**** according to the Japanese standard /JIS A 5908:2003/.

2.4 Placing on the market / Application rules

Placing on the market in the EU/EFTA is governed by /EU regulation 305/2011/ dated 9 March 2011. The products require a Declaration of Performance taking consideration of the /EN 13986:2005-03/ standard, Wood-based panels for use in construction – Characteristics, evaluation of conformity and marking; German and English versions /EN 13986:2005/, and CE marking.

The /EN 312:2010-12, Particleboards – Specifications/; German version /EN 312:2010/ and /EN 14322:2004-06, Wood-based panels – Melamine-faced boards for interior uses; Definitions, requirements and classification/; German version /EN 14322:2004/ also apply.

The respective national guidelines apply for use of the products.

2.5 Delivery status

Standard format [mm]: 5610 x 2070 & 2800 x 2070
Thickness range [mm]: 8 bis 40

2.6 Base materials / Ancillary materials

Primary products:

Raw chipboard with thicknesses between 2.5 and 40 mm and an average density of 660 kg/m³ comprising (specified as mass %age per 1 m³ of production):

- approx. 84-86% wood mass

The production of chipboard only uses fresh wood from thinning measures as well as sawmill leftovers, primarily spruce and pine wood. Up to 30% of the raw material is recycled wood which can be used as material.

- approx. 4-7% water

- approx. 8-10% UF glue

Comprising urea formaldehyde resin; the aminoplastic adhesive hardens fully during the pressing process through polycondensation.

- <1% paraffin wax emulsion: A paraffin wax emulsion is added to the formulation during gluing for the purpose of hydrophobicity (improving resistance to moisture).

For the coating:

-Decorative paper with a grammage of 60-120 g/m²

- Melamine formaldehyde resin: aminoplastic resin for impregnation of decorative paper for lamination; in the press, the resin hardens fully into a hard and hard-wearing surface.

2.7 Manufacture

Manufacturing the raw boards (EUROSPAN®):

1. Wood processing
- Log wood chipping
- Chip processing
- Waste wood processing
2. Drying the chips to approx. 2-3% residual moisture content
3. Sorting the chips